501768809 12/27/2011

PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Hiroki KITAYAMA	11/30/2011
Hideo NAKAGOSHI	11/30/2011
Kiyoshi KURIHARA	11/30/2011

RECEIVING PARTY DATA

Name:	Murata Manufacturing Co., Ltd.	
Street Address:	10-1 Higashikotari 1-chome	
City:	Nagaokakyo-shi, Kyoto-fu	
State/Country:	JAPAN	
Postal Code:	617-8555	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13337331

CORRESPONDENCE DATA

Fax Number: (571)313-7421 Phone: 571-313-7440

Email: mrhodes@kbiplaw.com

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via

US Mail.

Correspondent Name: Keating & Bennett LLP
Address Line 1: 1800 Alexander Bell Dr.

Address Line 2: Suite 200

Address Line 4: Reston, VIRGINIA 20191

ATTORNEY DOCKET NUMBER:	36856.2343
NAME OF SUBMITTER:	Michelle Rhodes

Total Attachments: 1

source=36856-2343-Client-20111212-Signed_Assignment#page1.tif

PATENT REEL: 027446 FRAME: 0219 OP \$40.00 1333733

Attorney Docket No.: 36856.2343

ASSIGNMENT (WORLDWIDE)

WHEREAS We, Hiroki KITAYAMA, Hideo NAKAGOSHI, and Kiyoshi KURIHARA (hereinafter referred to as ASSIGNOR), have invented and own a certain invention entitled <u>STRUCTURE FOR BONDING METAL PLATE AND</u> <u>PIEZOELECTRIC BODY AND BONDING METHOD</u> for which application for Letters Patent of the United States has been
executed on even date herewith; \underline{X} filed on $\underline{12/27/11}$ as Serial No. $\underline{13/337,331}$.
WHEREAS, Murata Manufacturing Co., Ltd., 10-1, Higashikotari 1-chome, Nagaokakyo-shi, Kyoto-fu Japan 617-8555 (hereinafter referred to as ASSIGNEE), is desirous of acquiring the entire interest in, to and under said invention and the United States Letters Patent to be obtained therefor;
NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that in consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration, ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the full and exclusive right, title and interest to the said invention and all Letters Patent of the United States to be obtained therefor on said application or any continuation, division, renewal, substitute or reissue thereof for the full term or terms for which the same may be granted; and all Letters Patent and applications therefor through the world, including all the rights accruing by virtue of the International Convention for the Protection of Industrial Property.
ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale;
ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent as may be known and accessible to ASSIGNOR and will testify as to the same in any interference or litigation related thereto and will promptly execute and deliver to ASSIGNEE or its legal representative any and all papers, instruments or affidavits required to apply for, obtain, maintain and enforce said application, said invention and said Letters Patent which may be necessary or desirable to carry out the purposes hereof.
Dated: November 30, 2011 Hiroki Kitayama Hiroki KITAYAMA
Dated: November 30, 2011 7fideo NAKAGOSHI Hideo NAKAGOSHI
Dated: November 30. 2011 <u>Kiyoshi Kurihara</u> Kiyoshi KURIHARA

Page 1 of 1

RECORDED: 12/27/2011

PATENT REEL: 027446 FRAME: 0220